

FIGURE 1

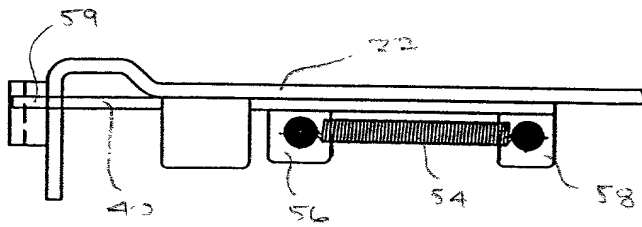


FIGURE 3

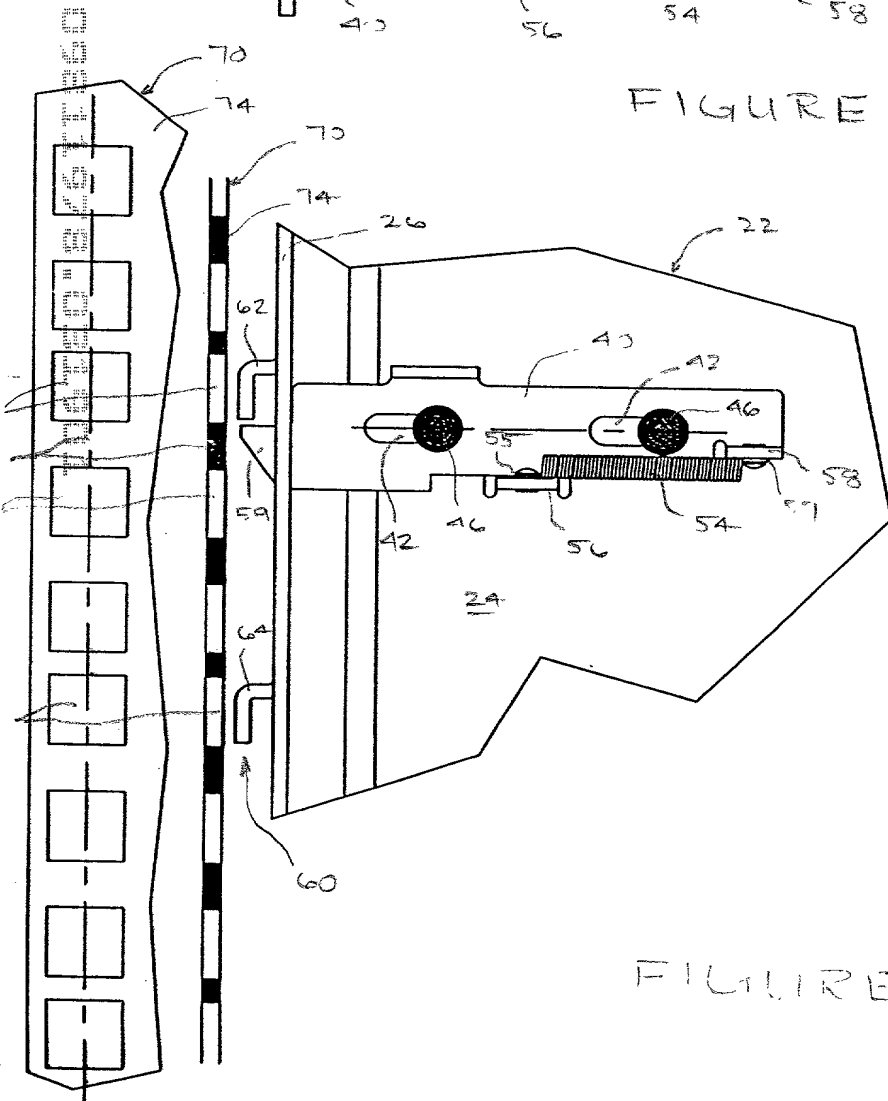


FIGURE 2

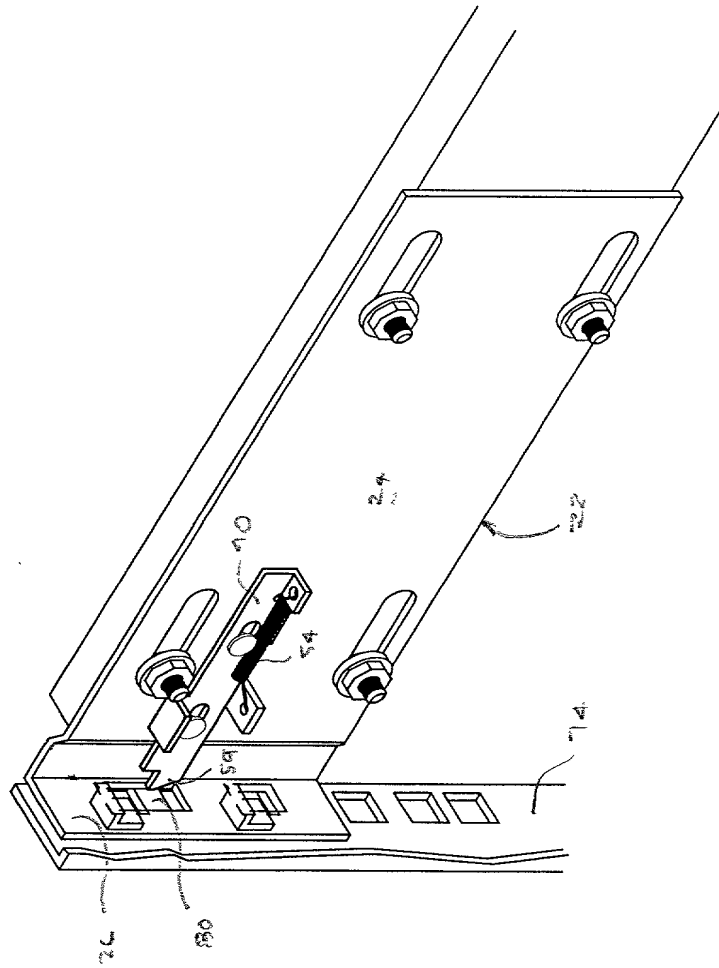


FIGURE 4

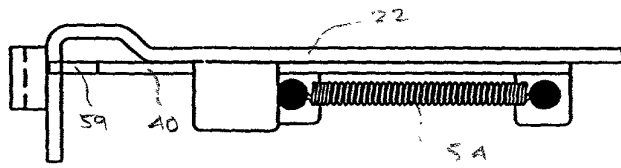


FIGURE 6

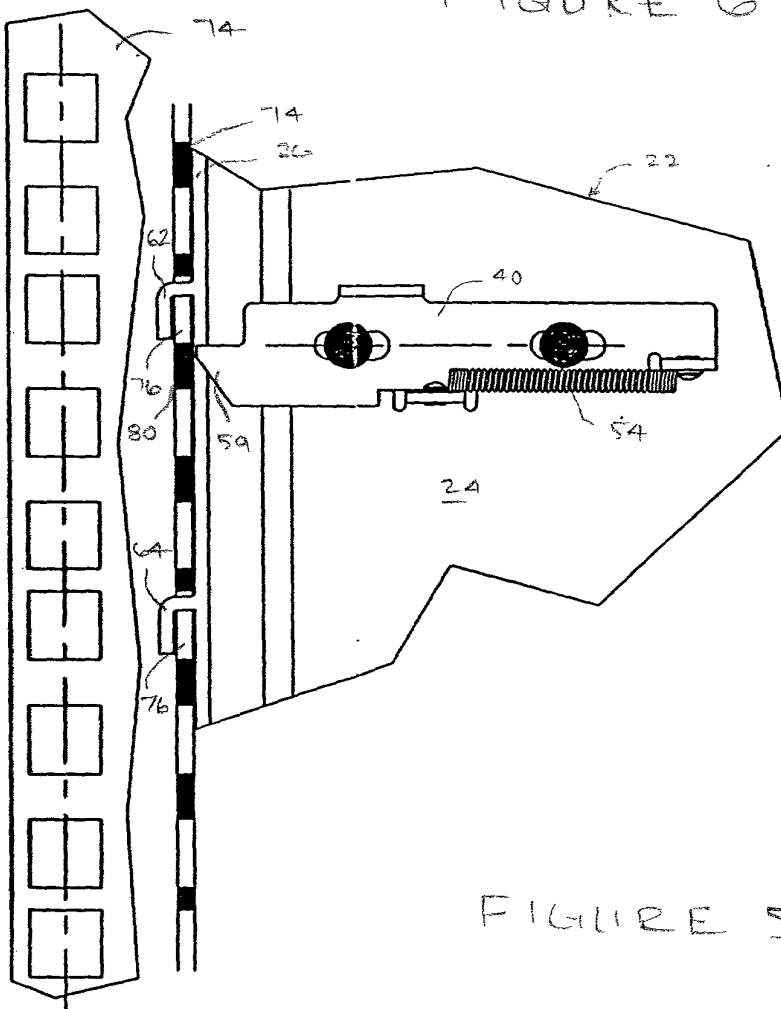


FIGURE 5

1. A method of manufacturing a device, comprising:
 a. providing a substrate; and
 b. forming a layer on the substrate, the layer comprising a material selected from the group consisting of a polymer, a metal, and a ceramic.

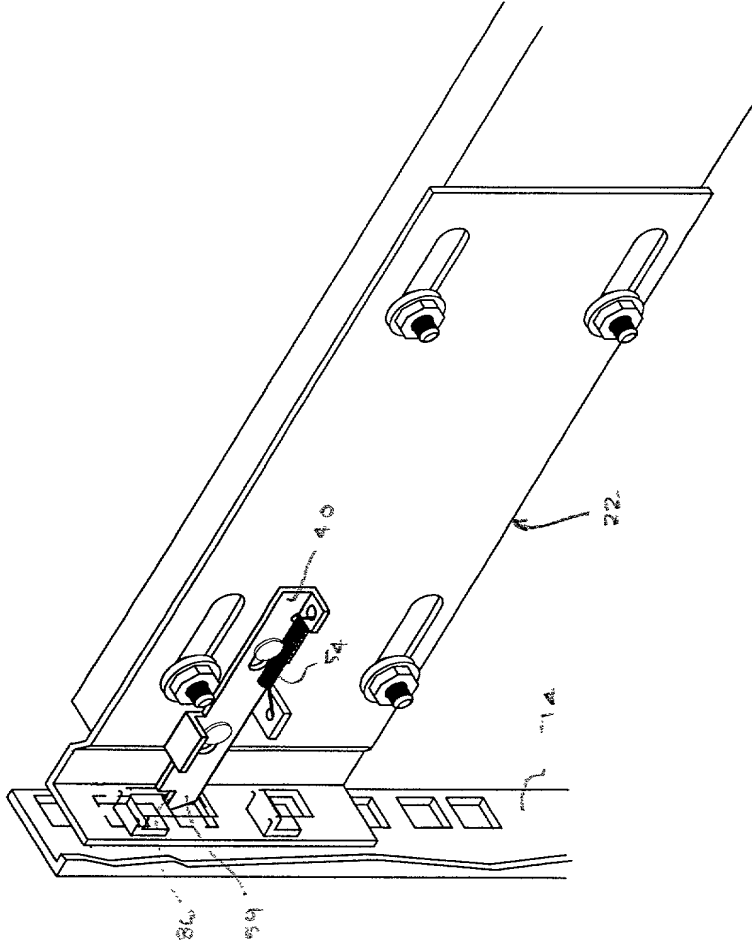


FIGURE 1

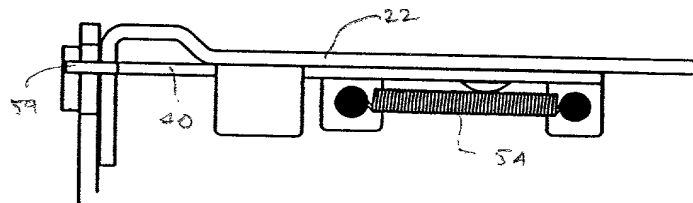


FIGURE 9

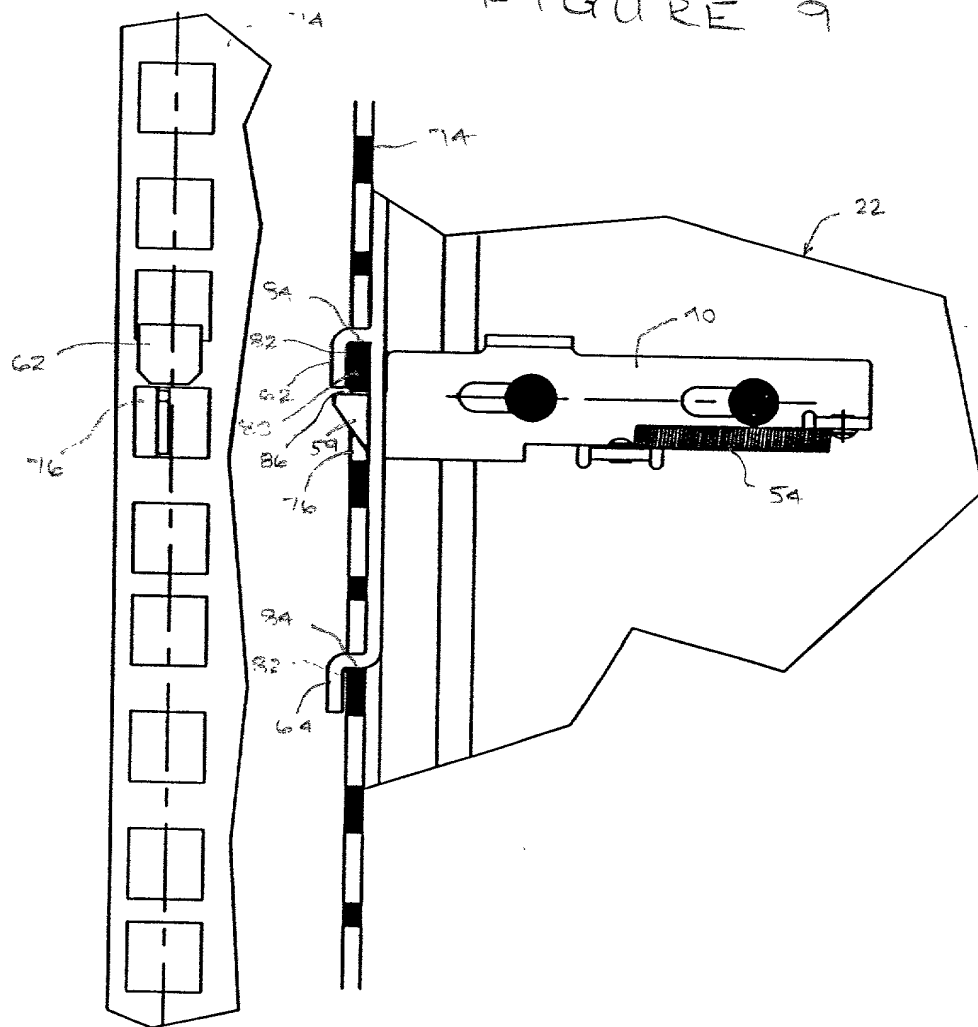
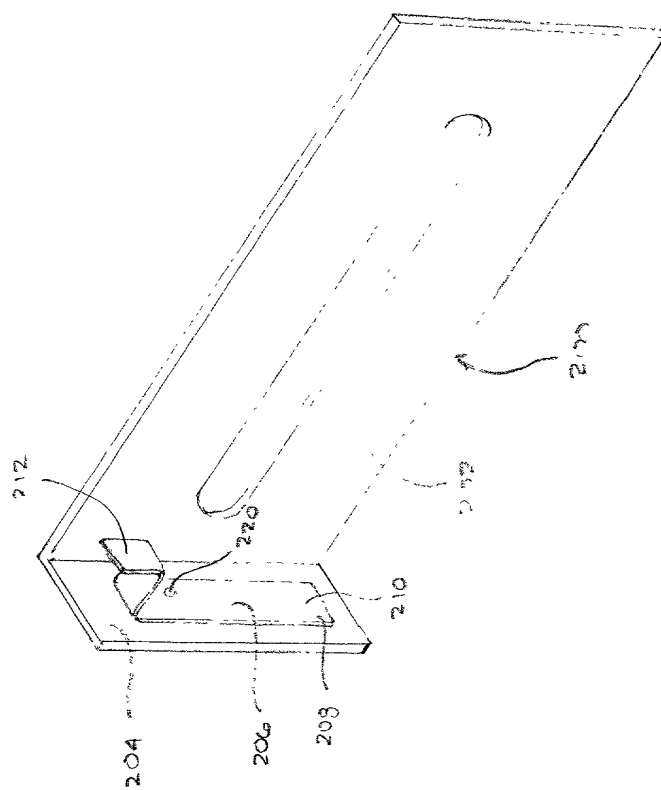


FIGURE 8



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(PRIOR NET)

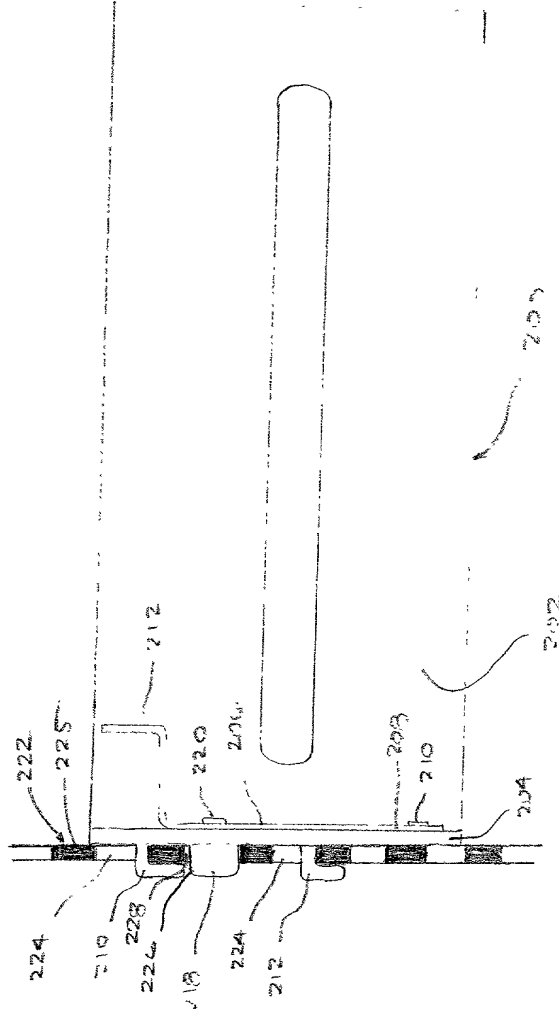


FIGURE 12

(PRIOR ART)

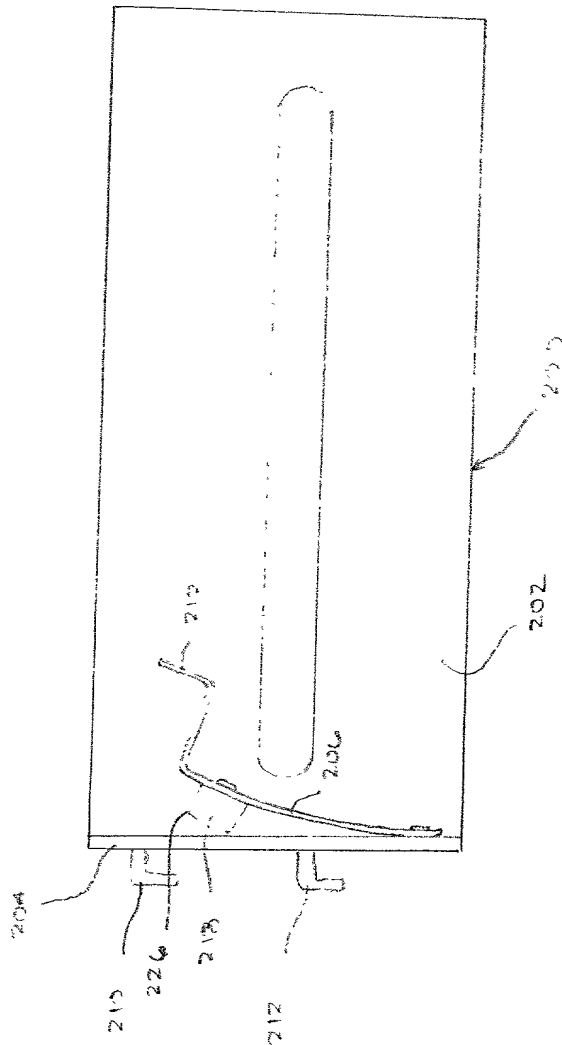


FIGURE 13

(PRIOR ART)

FIG. 14 is a perspective view of the assembly of FIG. 13, showing the assembly of the first and second rails 10 and 20, and the assembly of the first and second rails 10 and 20, and the assembly of the first and second rails 10 and 20.

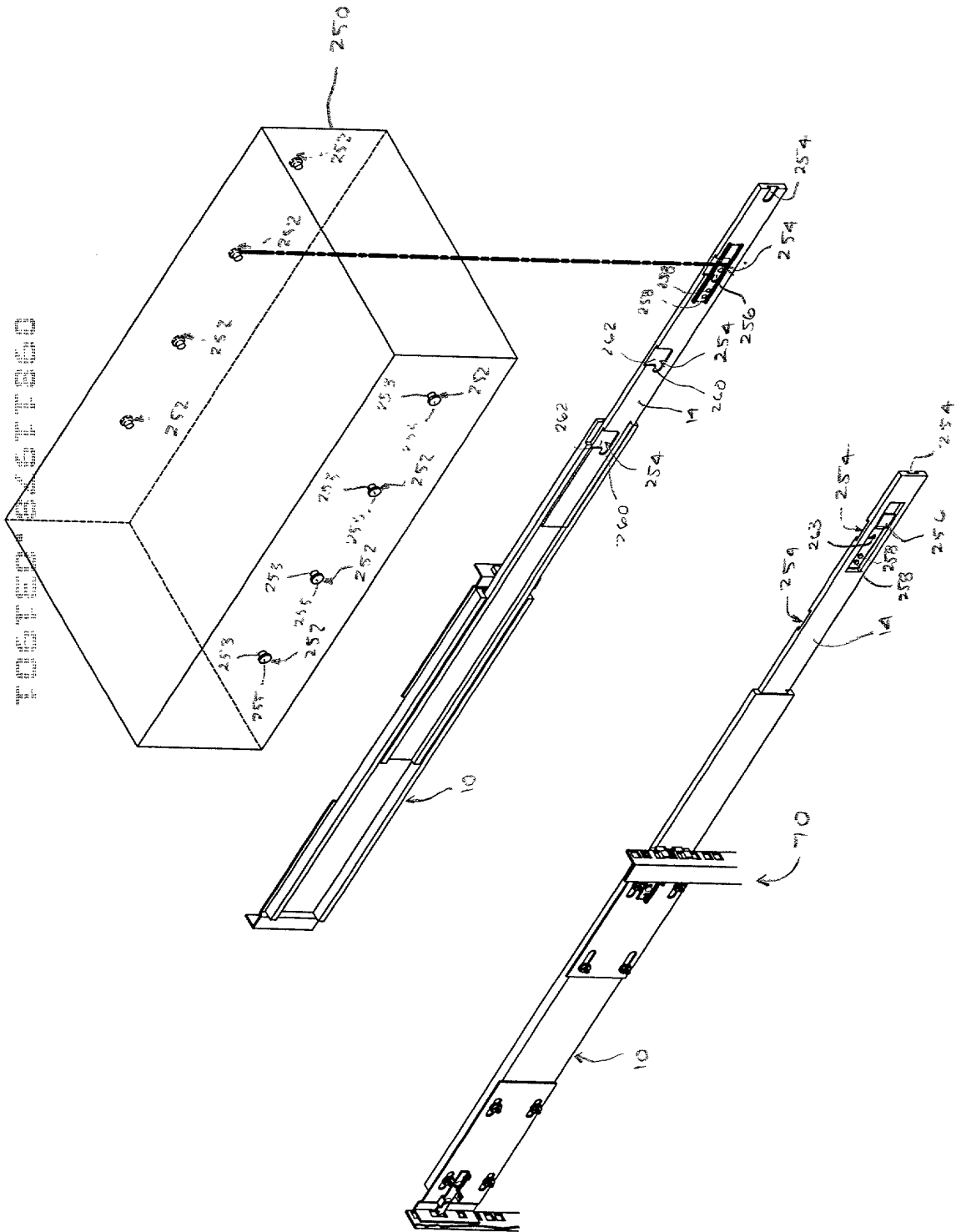


FIG. 15 is a perspective view of the assembly of FIG. 14, showing the assembly in a closed position. The assembly includes a housing 250, a door 252, and a latch 254. The door 252 is shown in a closed position, and the latch 254 is shown in a locked position. The assembly is shown in a perspective view, and the components are labeled with reference numerals.

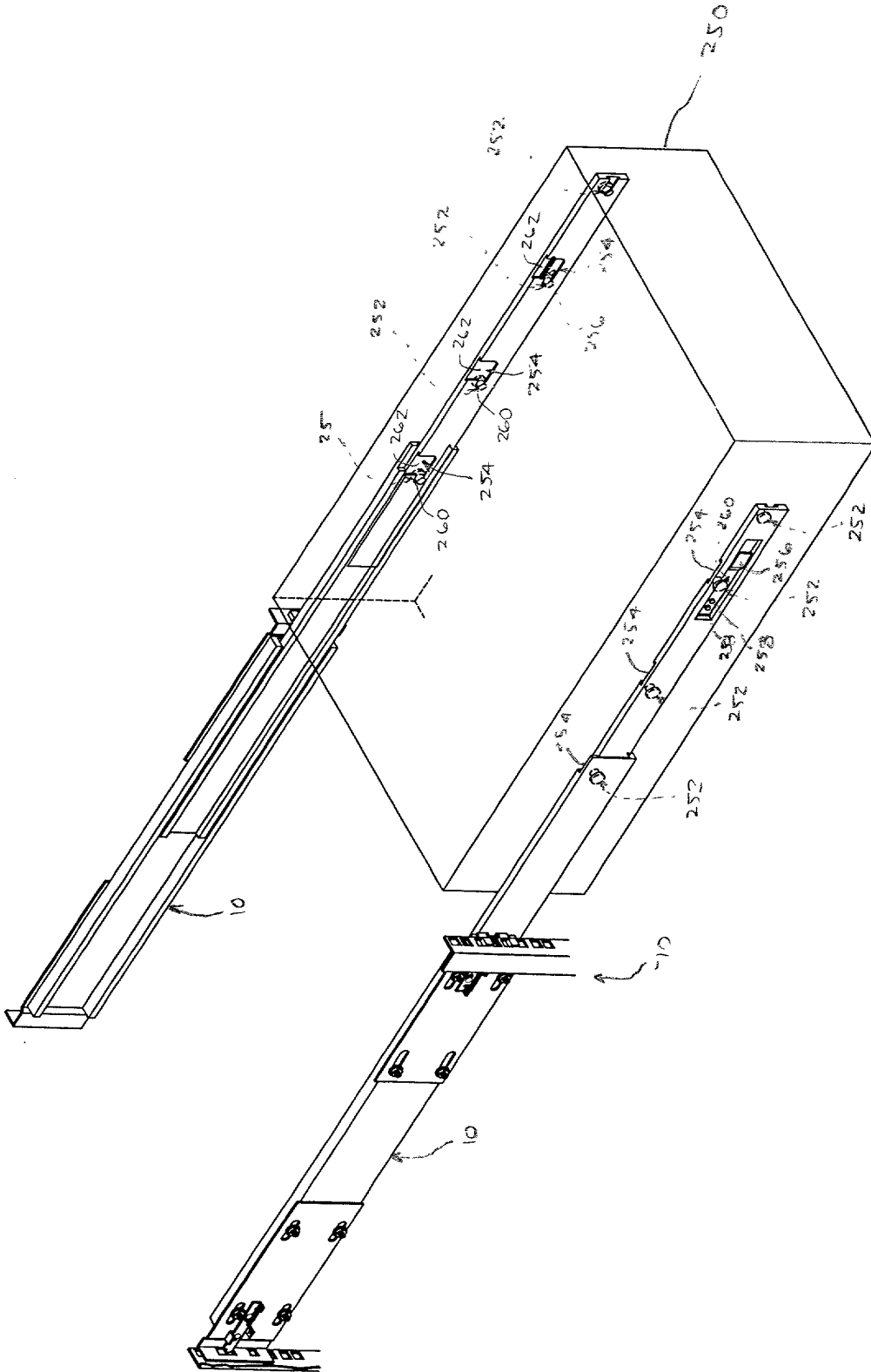


FIG. 15

Patented Feb 16, 1959

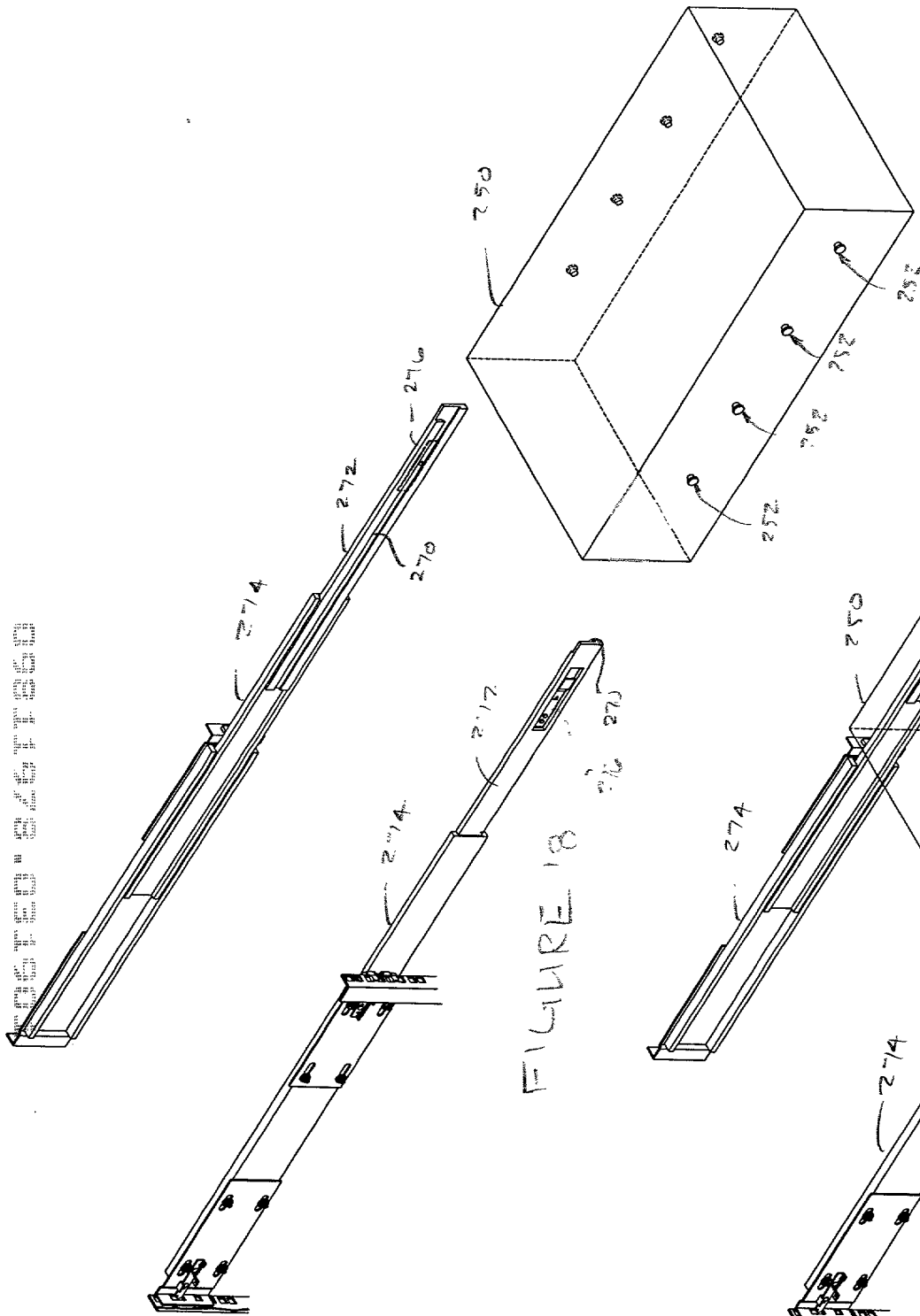


FIGURE 18

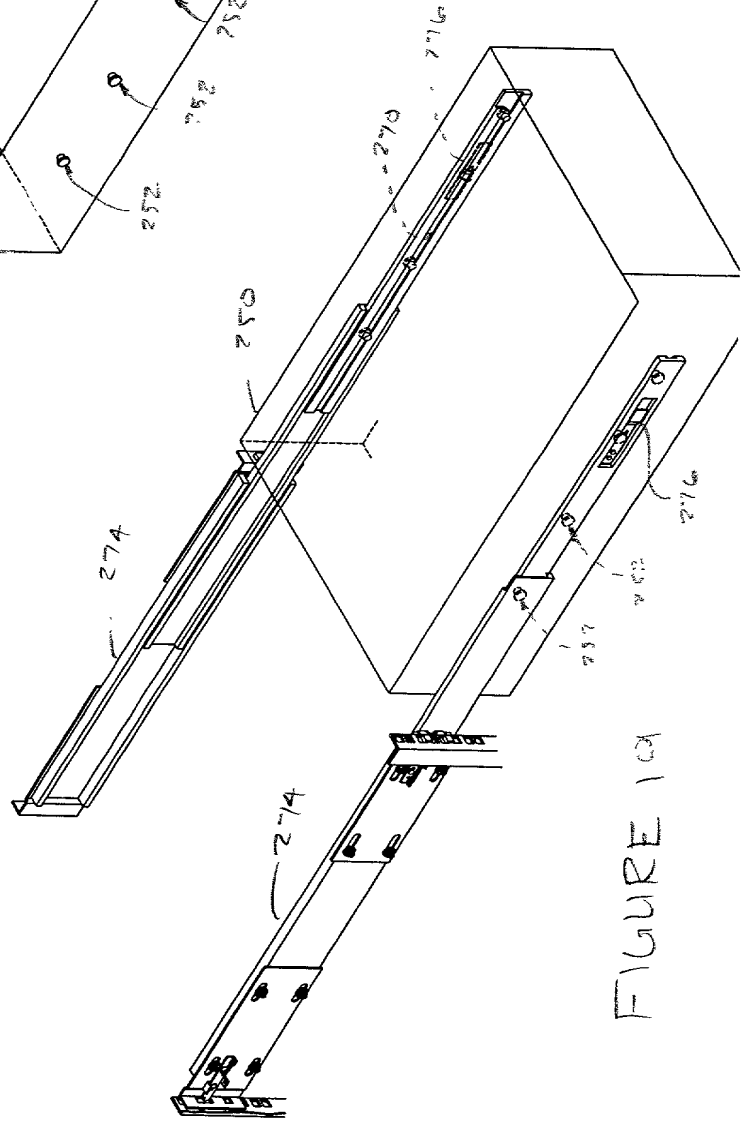


FIGURE 19